

### **MOSFET**

### OptiMOS<sup>™</sup>5 Power-Transistor, 80 V

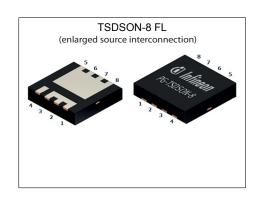
### **Features**

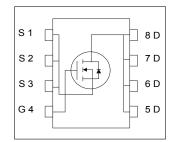
- Ideal for high frequency switching
  Optimized for chargers
  Excellent gate charge x R<sub>DS(on)</sub> product (FOM)
  Very low on-resistance R<sub>DS(on)</sub>
- N-channel, logic level

- 100% avalanche tested
  Pb-free plating; RoHS compliant
  Halogen-free according to IEC61249-2-21
  Higher solder joint reliable and light the Charles of th
- Qualified for Standard Grade applications



Parameter	Value	Unit	
<b>V</b> <sub>DS</sub>	80	V	
R <sub>DS(on),max</sub>	7.0	mΩ	
I <sub>D</sub>	40	Α	
Qoss	29	nC	
Q <sub>G</sub> (0V4.5V)	14	nC	











Type / Ordering Code	Package	Marking	Related Links
BSZ0602LS	PG-TSDSON-8 FL	0602LS	-

# OptiMOS<sup>™</sup>5 Power-Transistor, 80 V BSZ0602LS



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### OptiMOS<sup>™</sup>5 Power-Transistor, 80 V BSZ0602LS



# 1 Maximum ratings at $T_A$ =25 °C, unless otherwise specified

Table 2 Maximum ratings

Danamatan	Or week at		Value	s		Note / Total Constitution
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current	I <sub>D</sub>	- - -	-	40 40 13	A	T <sub>C</sub> =25 °C T <sub>C</sub> =100 °C T <sub>A</sub> =25 °C, R <sub>thJA</sub> =60 K/W <sup>1)</sup>
Pulsed drain current <sup>2)</sup>	I <sub>D,pulse</sub>	-	-	160	Α	T <sub>C</sub> =25 °C
Avalanche energy, single pulse <sup>3)</sup>	<b>E</b> AS	-	-	104	mJ	$I_{\rm D}$ =20 A, $R_{\rm GS}$ =25 $\Omega$
Gate source voltage	V <sub>GS</sub>	-20	-	20	V	-
Power dissipation	P <sub>tot</sub>	-	-	69	W	T <sub>C</sub> =25 °C
Operating and storage temperature	T <sub>j</sub> , T <sub>stg</sub>	-55	-	150	°C	IEC climatic category; DIN IEC 68-1: 55/150/56

#### 2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
raiailietei	Syllibol	Min.	Тур.	Max.	Oilit	Note / Test Condition
Thermal resistance, junction - case, bottom	R <sub>thJC</sub>	-	1.1	1.8	K/W	-
Device on PCB, minimal footprint	R <sub>thJA</sub>	-	-	62	K/W	-
Device on PCB, 6 cm <sup>2</sup> cooling area <sup>1)</sup>	R <sub>thJA</sub>	-	-	60	K/W	-

 $<sup>^{1)}</sup>$  Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.  $^{2)}$  See Diagram 3 for more detailed information  $^{3)}$  See Diagram 13 for more detailed information



### 3 Electrical characteristics

Table 4 Static characteristics

Davamatav	Or week at		Value	S	ļ,	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	80	-	-	V	V <sub>GS</sub> =0 V, I <sub>D</sub> =1 mA
Gate threshold voltage	V <sub>GS(th)</sub>	1.1	1.7	2.3	V	$V_{\rm DS}=V_{\rm GS},\ I_{\rm D}=36\ \mu {\rm A}$
Zero gate voltage drain current	I <sub>DSS</sub>	-	0.1 10	1 100	μA	V <sub>DS</sub> =80 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =25 °C V <sub>DS</sub> =80 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =125 °C
Gate-source leakage current	I <sub>GSS</sub>	-	1	100	nA	V <sub>GS</sub> =20 V, V <sub>DS</sub> =0 V
Drain-source on-state resistance	R <sub>DS(on)</sub>	-	7.4 5.9	9.4 7.0	mΩ	V <sub>GS</sub> =4.5 V, I <sub>D</sub> =10 A V <sub>GS</sub> =10 V, I <sub>D</sub> =20 A
Gate resistance <sup>1)</sup>	R <sub>G</sub>	-	1.3	2	Ω	-
Transconductance	<b>g</b> fs	26	52	-	S	$ V_{DS}  > 2 I_D R_{DS(on)max}, I_D = 20 A$

Table 5 Dynamic characteristics

Davamatav	Symbol		Values			
Parameter		Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance <sup>1)</sup>	Ciss	-	1800	2340	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =40 V, f=1 MHz
Output capacitance <sup>1)</sup>	Coss	-	280	364	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =40 V, f=1 MHz
Reverse transfer capacitance <sup>1)</sup>	C <sub>rss</sub>	-	12	21	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =40 V, f=1 MHz
Turn-on delay time	$t_{\sf d(on)}$	-	6.1	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =3 $\Omega$
Rise time	t <sub>r</sub>	-	4.8	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =3 $\Omega$
Turn-off delay time	$t_{ m d(off)}$	-	24.6	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =3 $\Omega$
Fall time	t <sub>f</sub>	-	5.8	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =3 $\Omega$

Table 6 Gate charge characteristics<sup>2)</sup>

Parameter	Symbol	Values			Unit	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Ullit	Note / Test Condition
Gate to source charge	Q <sub>gs</sub>	-	5	-	nC	V <sub>DD</sub> =40 V, I <sub>D</sub> =20 A, V <sub>GS</sub> =0 to 4.5 V
Gate to drain charge <sup>1)</sup>	$Q_{gd}$	-	5	7	nC	V <sub>DD</sub> =40 V, I <sub>D</sub> =20 A, V <sub>GS</sub> =0 to 4.5 V
Switching charge	Q <sub>sw</sub>	-	6.9	-	nC	V <sub>DD</sub> =40 V, I <sub>D</sub> =20 A, V <sub>GS</sub> =0 to 4.5 V
Gate charge total <sup>1)</sup>	Qg	-	14.1	18	nC	V <sub>DD</sub> =40 V, I <sub>D</sub> =20 A, V <sub>GS</sub> =0 to 4.5 V
Gate plateau voltage	V <sub>plateau</sub>	-	2.9	-	V	V <sub>DD</sub> =40 V, I <sub>D</sub> =20 A, V <sub>GS</sub> =0 to 4.5 V
Gate charge total, sync. FET	Q <sub>g(sync)</sub>	-	25	-	nC	V <sub>DS</sub> =0.1 V, V <sub>GS</sub> =0 to 10 V
Output charge <sup>1)</sup>	Qoss	-	29	39	nC	V <sub>DD</sub> =40 V, V <sub>GS</sub> =0 V

 $<sup>^{1)}</sup>$  Defined by design. Not subject to production test  $^{2)}$  See "Gate charge waveforms" for parameter definition

## OptiMOS<sup>™</sup>5 Power-Transistor, 80 V BSZ0602LS



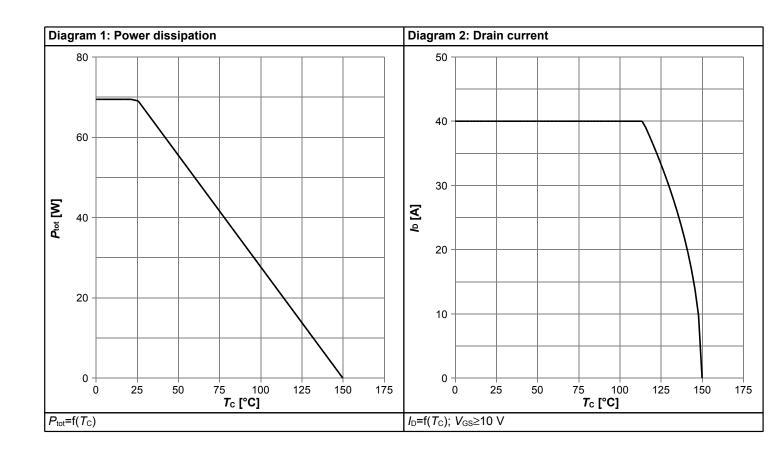
### Table 7 Reverse diode

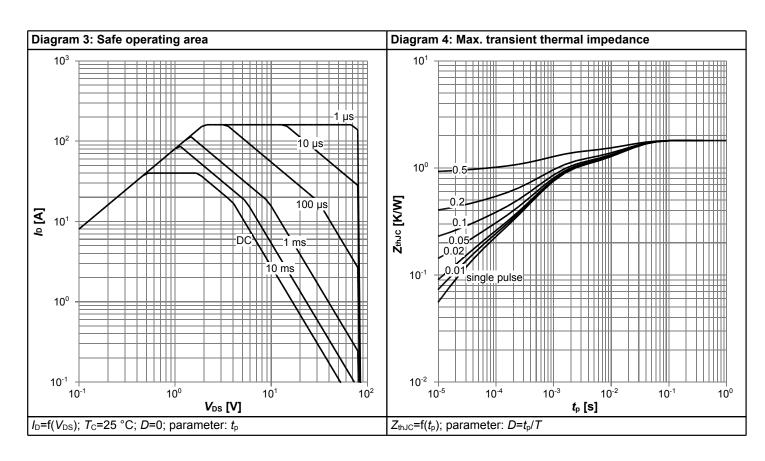
Parameter	Cymahal	Values			11:4	Nata / Tast Candition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continous forward current	Is	-	-	40	Α	T <sub>C</sub> =25 °C
Diode pulse current	I <sub>S,pulse</sub>	-	-	160	Α	T <sub>C</sub> =25 °C
Diode forward voltage	<b>V</b> <sub>SD</sub>	-	0.85	1.2	V	V <sub>GS</sub> =0 V, I <sub>F</sub> =20 A, T <sub>j</sub> =25 °C
Reverse recovery time <sup>1)</sup>	t <sub>rr</sub>	-	32	64	ns	V <sub>R</sub> =40 V, I <sub>F</sub> =20 A, d <i>i</i> <sub>F</sub> /d <i>t</i> =100 A/μs
Reverse recovery charge <sup>1)</sup>	Qrr	-	27	54	nC	V <sub>R</sub> =40 V, I <sub>F</sub> =20 A, d <i>i</i> <sub>F</sub> /d <i>t</i> =100 A/μs

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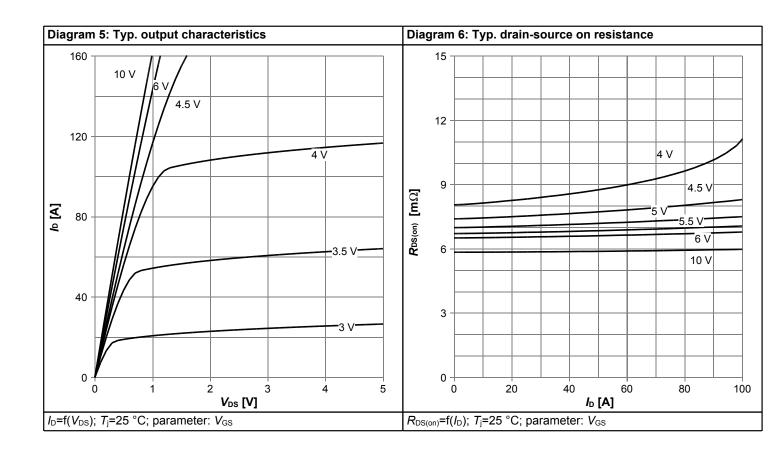


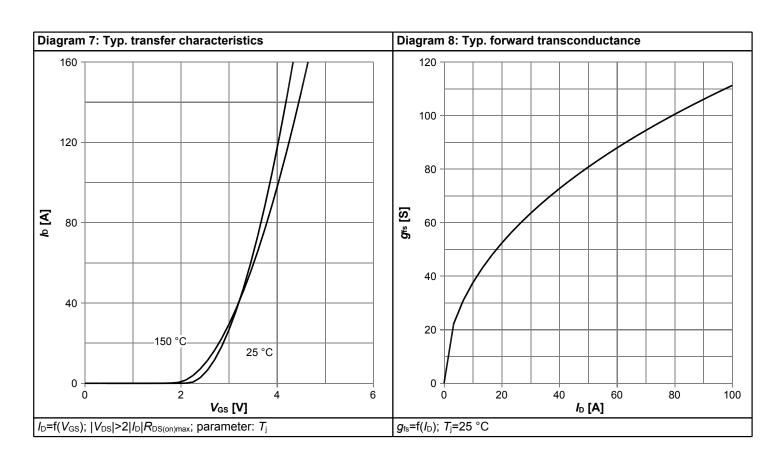
### 4 Electrical characteristics diagrams



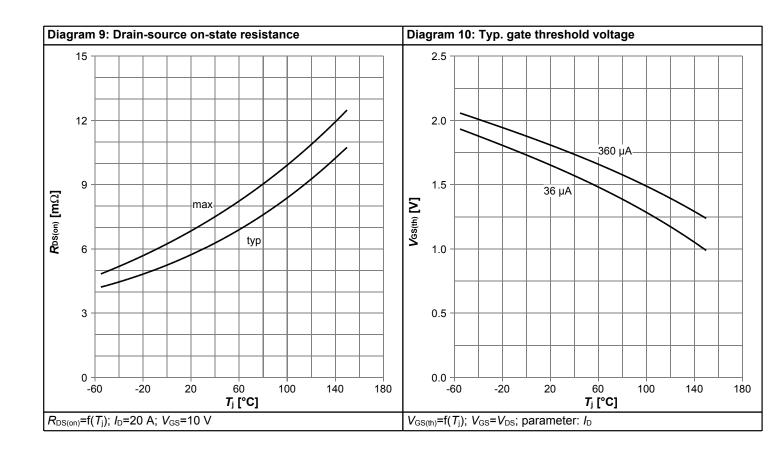


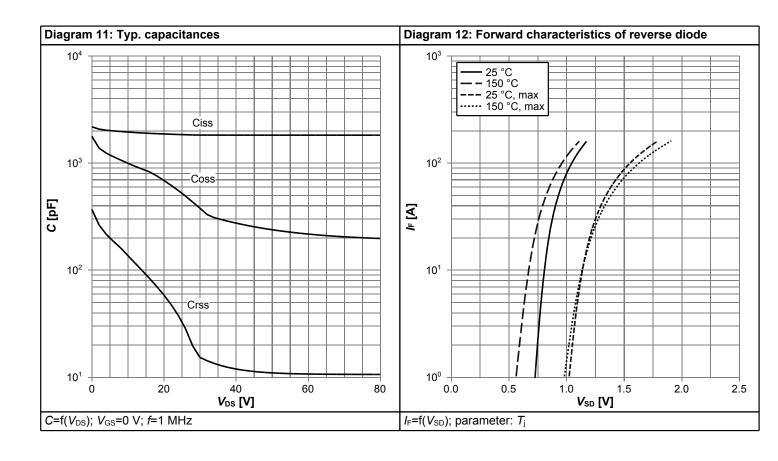




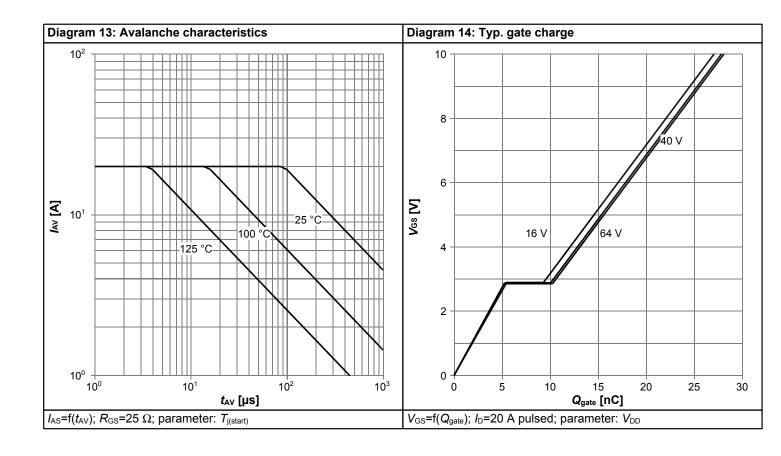


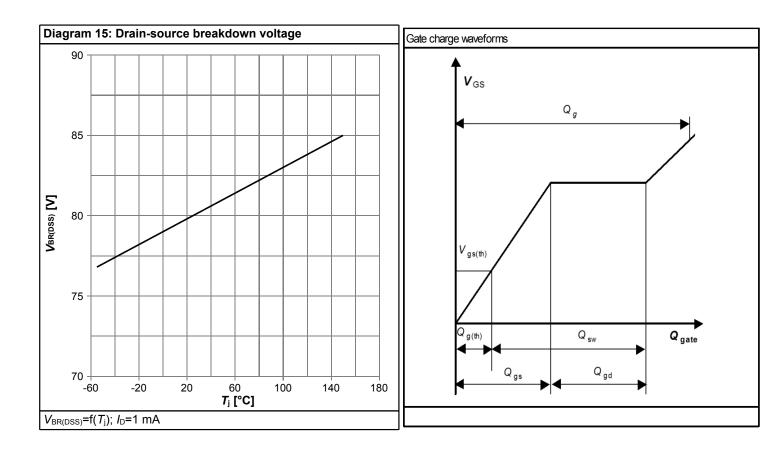














### 5 Package Outlines

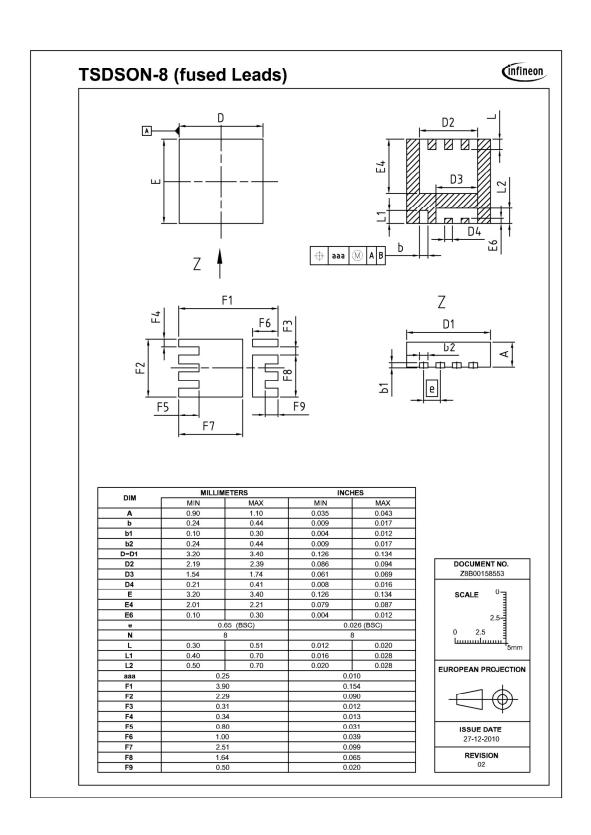


Figure 1 Outline PG-TSDSON-8 FL, dimensions in mm/inches

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### **Revision History**

BSZ0602LS

Revision: 2016-10-20, Rev. 2.2

#### **Previous Revision**

Revision	Date	Subjects (major changes since last revision)					
2.0	2016-03-31	Release of final version					
2.1	2016-08-10	Update features					
2.2	2016-10-20	Update " Features "					

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